Vorläufige Daten
preliminary data

IGBT-Wechselrichter / IGBT-inverter

Höchstzulässige Werte / maximum rated values

Kollektor-Emitter-Sperrspannung collector-emitter voltage	T_{vj} = 25°C T_{vj} = -25°C	V_{CES}	3300 3300	V
Kollektor-Dauergleichstrom DC-collector current	T_C = 80°C, T_{vj} = 150°C T_C = 25°C, T_{vj} = 150°C	$I_{C\ nom}$ I_C	1200 2300	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	t_P = 1 ms, T_C = 80°C	I_{CRM}	2400	A
Gesamt-Verlustleistung total power dissipation	T_C = 25°C, T_{vj} = 150°C	P_{tot}	14,5	kW
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte / characteristic values

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	I_C = 1200 A, V_{GE} = 15 V I_C = 1200 A, V_{GE} = 15 V	T_{vj} = 25°C T_{vj} = 125°C	$V_{CE\ sat}$		3,00 3,70	3,65 4,45	V V
Gate-Schwellenspannung gate threshold voltage	I_C = 120 mA, V_{CE} = V_{GE}, T_{vj} = 25°C		V_{GEth}	4,2	5,1	6,0	V
Gateladung gate charge	V_{GE} = -15 V ... +15 V, V_{CE} = 1800V		Q_G		22,0		µC
Interner Gatewiderstand internal gate resistor	T_{vj} = 25°C		R_{Gint}		0,42		Ω
Eingangskapazität input capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{ies}		145		nF
Rückwirkungskapazität reverse transfer capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{res}		8,00		nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V_{CE} = 3300 V, V_{GE} = 0 V, T_{vj} = 25°C		I_{CES}			5,0	mA
Gate-Emitter Reststrom gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25°C		I_{GES}			400	nA
Einschaltverzögerungszeit (ind. Last) turn-on delay time (inductive load)	I_C = 1200 A, V_{CE} = 1800 V V_{GE} = ±15 V R_{Gon} = 4,7 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	$t_{d\ on}$		1,00 1,00		µs µs
Anstiegszeit (induktive Last) rise time (inductive load)	I_C = 1200 A, V_{CE} = 1800 V V_{GE} = ±15 V R_{Gon} = 4,7 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	t_r		0,40 0,40		µs µs
Abschaltverzögerungszeit (ind. Last) turn-off delay time (inductive load)	I_C = 1200 A, V_{CE} = 1800 V V_{GE} = ±15 V R_{Goff} = 4,7 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	$t_{d\ off}$		3,70 3,90		µs µs
Fallzeit (induktive Last) fall time (inductive load)	I_C = 1200 A, V_{CE} = 1800 V V_{GE} = ±15 V R_{Goff} = 4,7 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	t_f		0,25 0,35		µs µs
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I_C = 1200 A, V_{CE} = 1800 V, dI/dt = 5400 A/µs V_{GE} = ±15 V, L_S = 60 nH R_{Gon} = 2,0 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	E_{on}		2400 3150		mJ mJ
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I_C = 1200 A, V_{CE} = 1800 V V_{GE} = ±15 V, L_S = 60 nH R_{Goff} = 4,7 Ω, C_{GE} = 330 nF	T_{vj} = 25°C T_{vj} = 125°C	E_{off}		1400 1900		mJ mJ
Kurzschlußverhalten SC data	t_P ≤ 10 µs, V_{GE} ≤ 15 V T_{vj} = 125°C, V_{CC} = 2500 V, V_{CEmax} = V_{CES} -L_{sCE} ·di/dt		I_{SC}		5200		A
Innerer Wärmewiderstand thermal resistance, junction to case	pro IGBT per IGBT		R_{thJC}			8,50	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro IGBT / per IGBT λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)		R_{thCH}		9,00		K/kW

prepared by: Karl-Heinz Hoppe	date of publication: 2004-4-8
approved by: Thomas Schütze	revision: 2.1

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Diode-Wechselrichter / diode-inverter

Höchstzulässige Werte / maximum rated values

Periodische Spitzensperrspannung repetitive peak reverse voltage	T_{vj} = 25°C T_{vj} = -25°C	V_{RRM}	3300 3300	V
Dauergleichstrom DC forward current		I_F	1200	A
Periodischer Spitzenstrom repetitive peak forward current	t_P = 1 ms	I_{FRM}	2400	A
Grenzlastintegral I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C	I²t	440	kA²s
Spitzenverlustleistung maximum power dissipation	T_{vj} = 125°C	P_{RQM}	1800	kW
Mindesteinschaltdauer minimum turn-on time		$t_{Fon\ min}$	10,0	µs

Charakteristische Werte / characteristic values

			min.	typ.	max.	
Durchlassspannung forward voltage	I_F = 1200 A, V_{GE} = 0 V I_F = 1200 A, V_{GE} = 0 V	V_F		2,60 2,55	t.b.d.	V V
Rückstromspitze peak reverse recovery current	I_F = 1200 A, - di_F/dt = 5400 A/µs V_R = 1800 V V_{GE} = -15 V	I_{RM}		1400 1600		A A
Sperrverzögerungsladung recovered charge	I_F = 1200 A, - di_F/dt = 5400 A/µs V_R = 1800 V V_{GE} = -15 V	Q_r		810 1450		µC µC
Abschaltenergie pro Puls reverse recovery energy	I_F = 1200 A, - di_F/dt = 5400 A/µs V_R = 1800 V V_{GE} = -15 V	E_{rec}		750 1500		mJ mJ
Innerer Wärmewiderstand thermal resistance, junction to case	pro Diode per diode	R_{thJC}			17,0	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Diode / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		18,0		K/kW

prepared by: Karl-Heinz Hoppe	date of publication: 2004-4-8
approved by: Thomas Schütze	revision: 2.1

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Modul / module

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min.	V_{ISOL}		10,2		kV
Teilentladungs Aussetzspannung partial discharge extinction voltage	RMS, f = 50 Hz, Q_{PD} typ 10 pC (acc. to IEC 1287)	V_{ISOL}		5,1		kV
Kollektor-Emitter-Gleichsperrspannung DC stability	T_{vj} = 25°C, 100 fit	$V_{CE\ D}$		2150		V
Material Modulgrundplatte material of module baseplate				AlSiC		
Material für innere Isolation material for internal insulation				AlN		
Kriechstrecke creepage distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal			64,0 56,0		mm
Luftstrecke clearance distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal			40,0 26,0		mm
Vergleichszahl der Kriechwegbildung comparative tracking index		CTI		> 600		
			min.	typ.	max.	
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		6,00		K/kW
Modulinduktivität stray inductance module		L_{sCE}		18		nH
Modulleitungswiderstand, Anschlüsse - Chip module lead resistance, terminals - chip	T_C = 25°C, pro Schalter / per switch	$R_{CC'+EE'}$		0,12		mΩ
Höchstzulässige Sperrschichttemperatur maximum junction temperature	Wechselrichter / inverter	$T_{vj\ max}$			150	°C
Temperatur im Schaltbetrieb temperature under switching conditions	Wechselrichter / inverter	$T_{vj\ op}$	-40		125	°C
Lagertemperatur storage temperature		T_{stg}	-40		125	°C
Anzugsdrehmoment f. mech. Befestigung mounting torque	Schraube / screw M6	M	4,25	-	5,75	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	Schraube / screw M4 Schraube / screw M8	M	1,8 8,0	- -	2,1 10	Nm Nm
Gewicht weight		G		1400		g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but guarantees no characteristics. It is valid with the appropriate technical explanations.

prepared by: Karl-Heinz Hoppe	date of publication: 2004-4-8
approved by: Thomas Schütze	revision: 2.1

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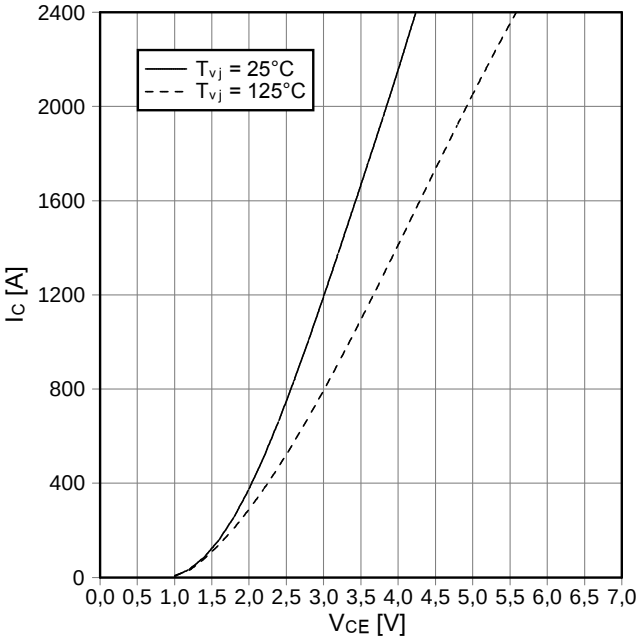
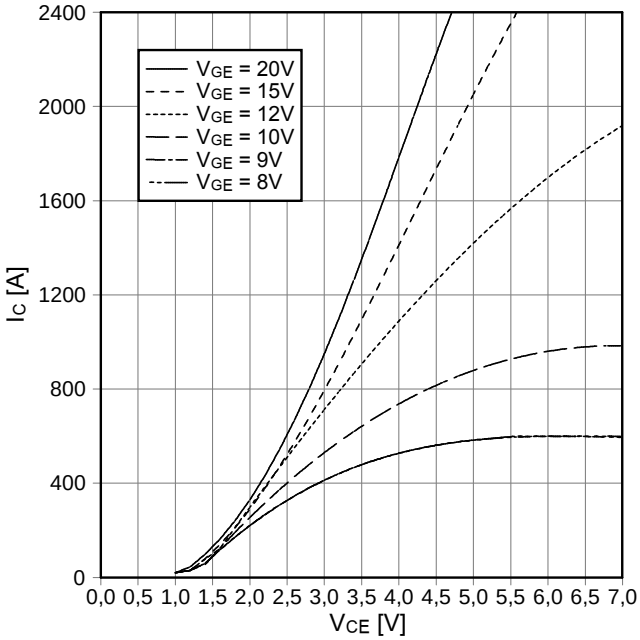
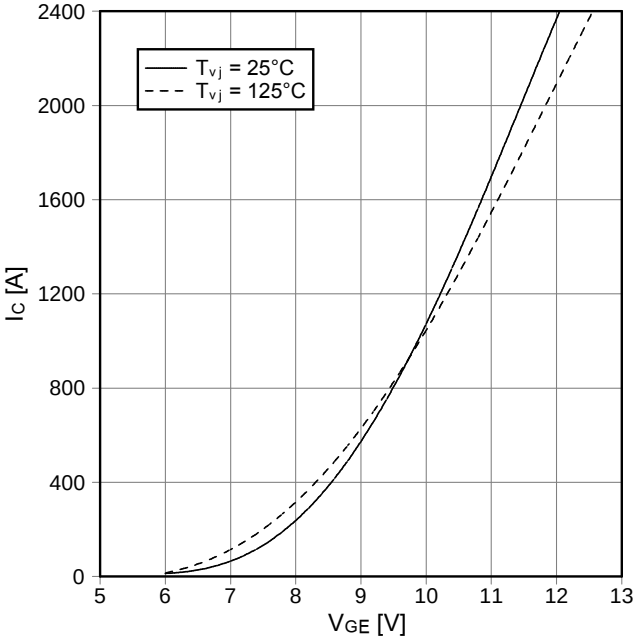
Ausgangskennlinie IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
$I_C = f(V_{CE})$
V_{GE} = 15 V



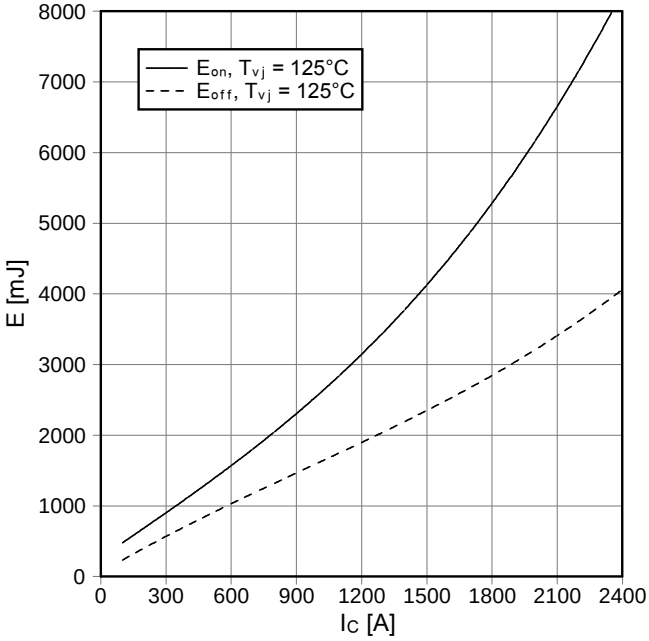
Ausgangskennlinienfeld IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
$I_C = f(V_{CE})$
T_{vj} = 125°C



Übertragungscharakteristik IGBT-Wechselr. (typisch)
transfer characteristic IGBT-inverter (typical)
$I_C = f(V_{GE})$
V_{CE} = 20 V



Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-inverter (typical)
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$
V_{GE} = ±15 V, R_{Gon} = 2 Ω, R_{Goff} = 4,7 Ω, V_{CE} = 1800 V, C_{GE} = 330 nF



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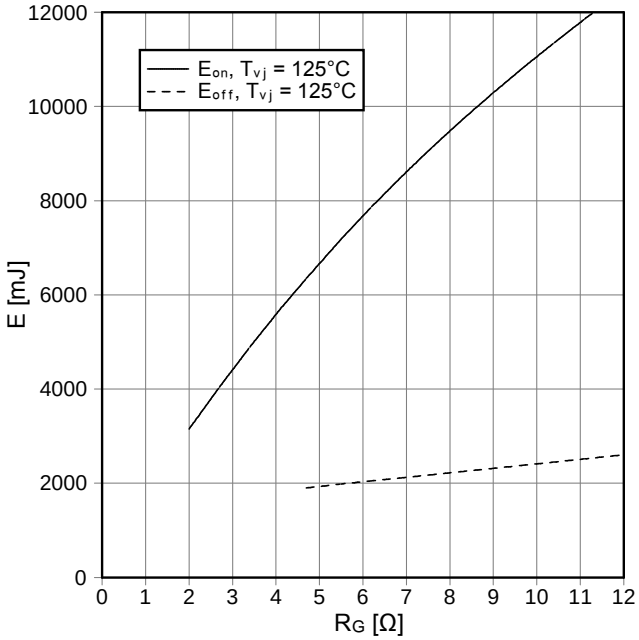
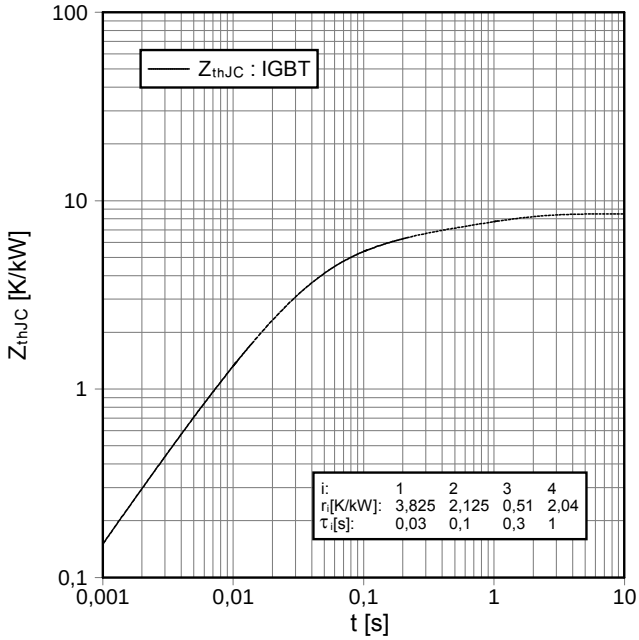
Vorläufige Daten
preliminary data

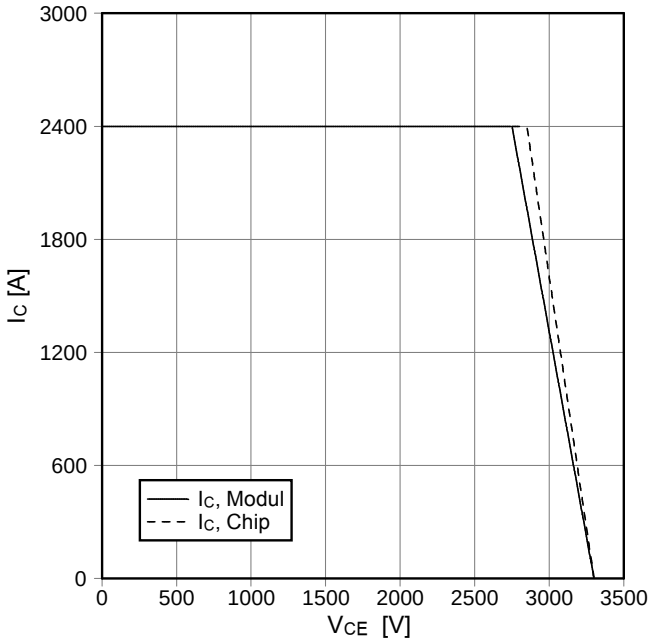
Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-Inverter (typical)
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$
V_{GE} = ±15 V, I_C = 1200 A, V_{CE} = 1800 V, C_{GE} = 330 nF



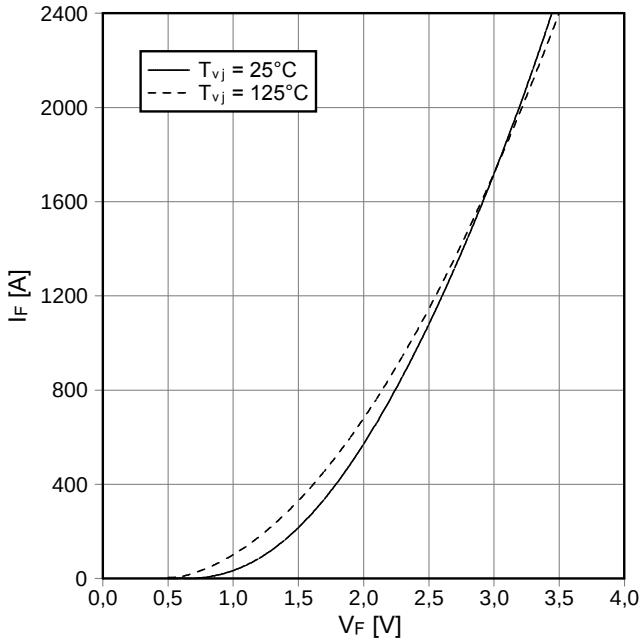
Transienter Wärmewiderstand IGBT-Wechselr.
transient thermal impedance IGBT-inverter
$Z_{thJC} = f(t)$



Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)
reverse bias safe operating area IGBT-inv. (RBSOA)
$I_C = f(V_{CE})$
V_{GE} = ±15 V, R_{Goff} = 4,7 Ω, T_{vj} = 125°C, C_{GE} = 330 nF



Durchlaßkennlinie der Diode-Wechselr. (typisch)
forward characteristic of diode-inverter (typical)
$I_F = f(V_F)$



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Vorläufige Daten
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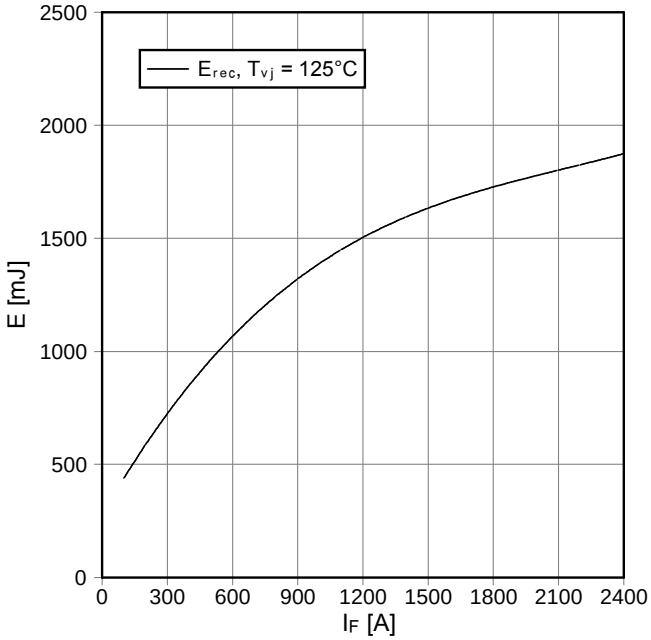
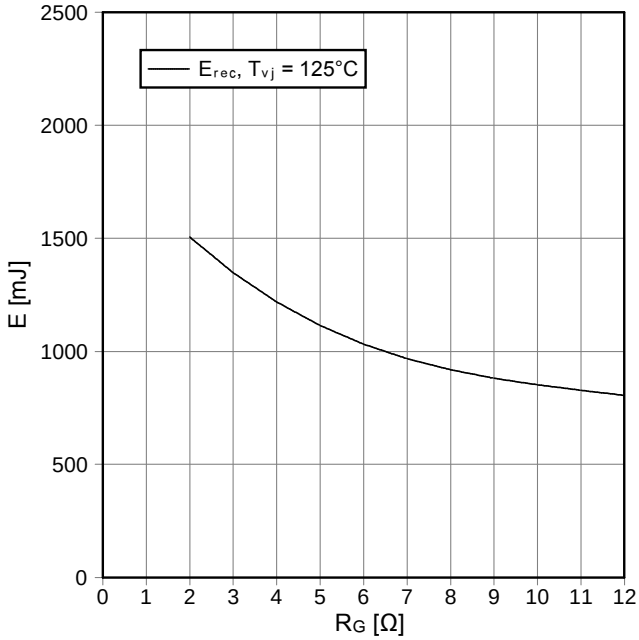
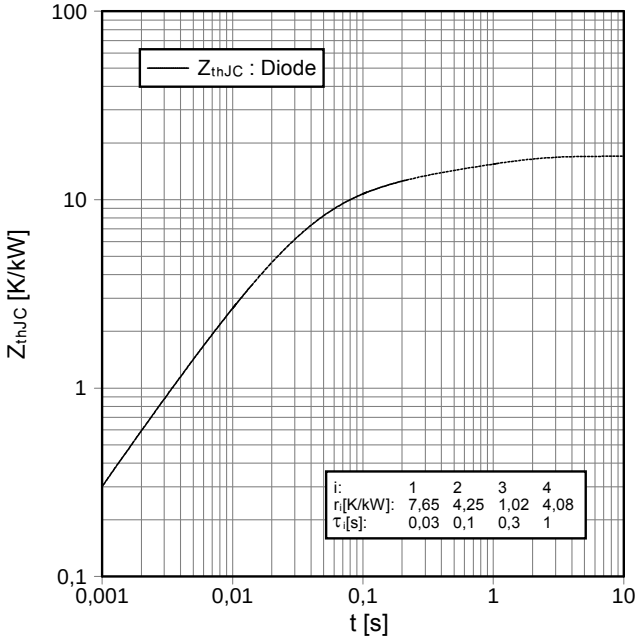
Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
$E_{rec} = f(I_F)$
$R_{Gon} = 2\ \Omega$, $V_{CE} = 1800$ V



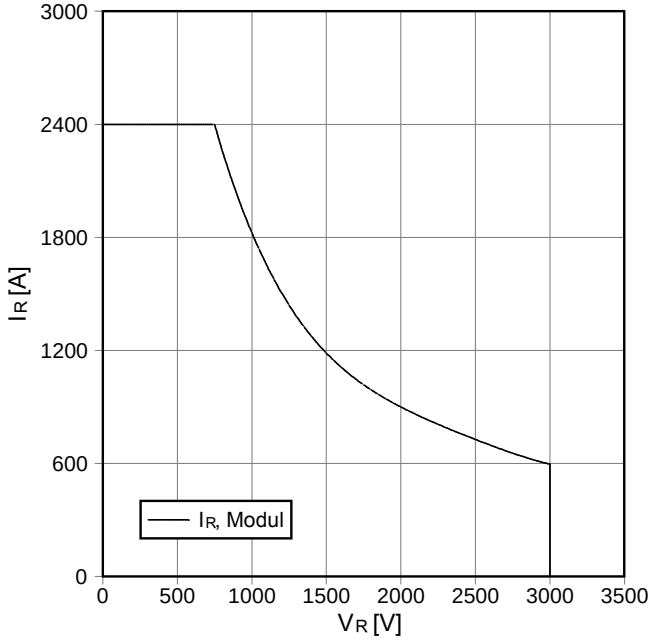
Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
$E_{rec} = f(R_G)$
$I_F = 1200$ A, $V_{CE} = 1800$ V



Transienter Wärmewiderstand Diode-Wechselr.
transient thermal impedance diode-inverter
$Z_{thJC} = f(t)$



Sicherer Arbeitsbereich Diode-Wechselr. (SOA)
save operation area diode-inverter (SOA)
$I_R = f(V_R)$
$T_{vj} = 125$°C



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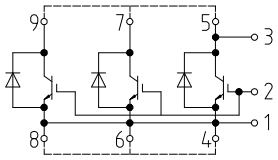
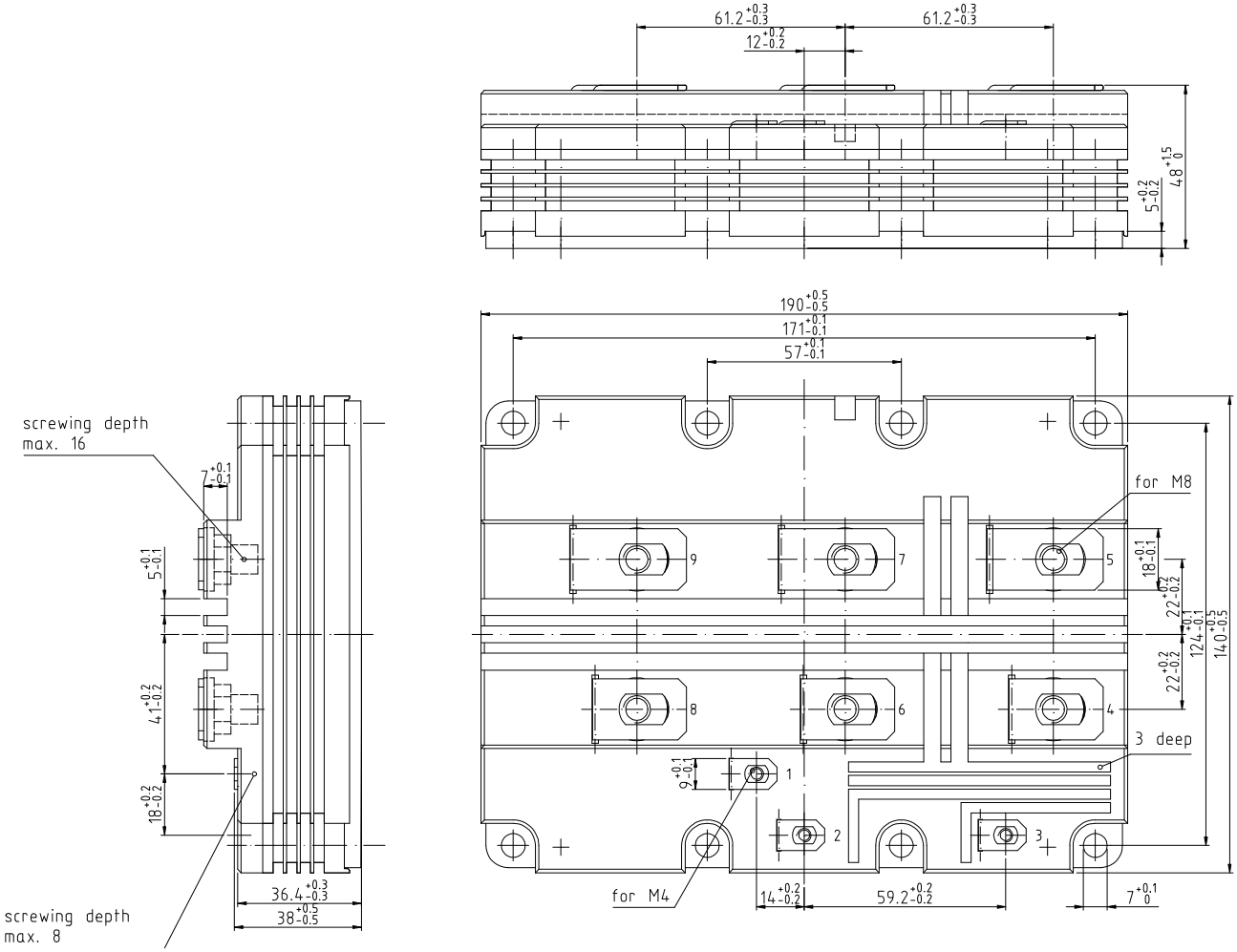
Schaltplan / circuit diagram



Gehäuseabmessungen / package outlines



prepared by: Karl-Heinz Hoppe	date of publication: 2004-4-8
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